

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Bo WANG	06/07/2024
Lei ZHU	06/07/2024
Xiaofeng SUI	06/07/2024
Dejie LIU	06/07/2024
Longfei CONG	06/07/2024
RECEIVING PARTY DATA	
Company Name:	SHENZHEN MINDRAY BIO-MEDICAL ELECTRONICS CO., LTD.
Street Address:	Mindray Building, Keji 12th Road South
Internal Address:	High-Tech Industrial Park, Nanshan District
City:	Shenzhen, Guangdong
State/Country:	CHINA
Postal Code:	518057
Company Name:	SHENZHEN MINDRAY SCIENTIFIC CO., LTD.
Street Address:	6/F, Bldg. 2, 1203 Nanhuan Avenue
Internal Address:	Yutang Block, Guangming District
City:	Shenzhen, Guangdong
State/Country:	CHINA
Postal Code:	518000
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17174206
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	51WG-329169
NAME OF SUBMITTER:	Annie Wong
SIGNATURE:	Annie Wong
DATE SIGNED:	06/10/2024
Total Attachments: 2 source=Assignment_17174206#page1.tif source=Assignment_17174206#page2.tif	

ASSIGNMENT

WHEREAS I/We, the below named inventor(s) (hereinafter referred to as "Assignor(s)"), of an invention or inventions (hereinafter referred to as "Invention(s)") described in an application for United States Letters Patent entitled:

ULTRASOUND IMAGE PROCESSING DEVICE AND METHOD, AND COMPUTER-READABLE STORAGE MEDIUM

filed on February 11, 2021, as United States Patent Application No. 17/174,206 (Confirmation No. 1560);

WHEREAS,

SHENZHEN MINDRAY BIO-MEDICAL ELECTRONICS CO., LTD., a corporation of China, whose address is: Mindray Building, Keji 12th Road South, High-tech Industrial Park, Nanshan District, Shenzhen, Guangdong 518057 CHINA

SHENZHEN MINDRAY SCIENTIFIC CO., LTD., a corporation of China, whose address is: 6/F, Bldg. 2, 1203 Nanhuan Avenue, Yulang Block, Guangming District, Shenzhen, Guangdong 518000 CHINA

(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to the Invention(s) in all countries throughout the world, and in and to all applications for patents on the Invention(s) in all countries throughout the world, including any PCT International Applications and all national stage applications based thereon that may be filed, and all patents issued upon such applications in all countries throughout the world;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/We, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to the Invention(s), the above-referenced application(s) that disclose and claim the Invention(s), any PCT International Applications and all national stage applications based thereon that may be filed, any other applications for patents filed anywhere in the world that disclose and claim the Invention(s), and all divisions and continuations of any such application, and all patents which may be granted thereon, and all reissues thereof, and all rights to claim priority in any country on the basis of any such applications, and all extensions, renewals, and reissues thereof; and I/We hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for the Invention(s) to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting the Invention(s), and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to the Invention(s) in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for the Invention(s) in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys empowered in the Power of Attorney in this application to insert the filing date and application number of the above-referenced application(s) when known.

IN TESTIMONY WHEREOF, I/We have hereunto set my/our hands.

Name: Bo WANG
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By: Bo WANG
Date: 06/07/2024

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